

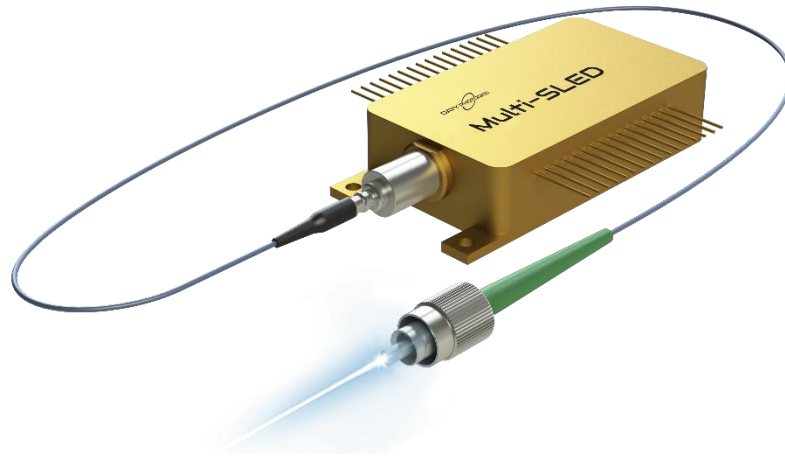
DATASHEET

Multi-Channel Superluminescent Diode Source

Optical Spectral Engine (OSE2)

32 Pin-Butterfly Package, 6 SLEDs: 1300nm, 1390nm, 1480nm, 1550nm, 1615nm, 1680nm, PM Fiber, High Degree of Polarization, Spectral Coverage: 1265nm-1725nm, FWHM: 460nm, CW: 1495nm, Light Output Power >40mW

DAYY Photonics Part Number: ASM000008



#DAY-OSE2-1300_1390_1480_1550_1615_1680-PM-HP-1265_1725-460-1495-40_DS_2026-01-01

This document is the property of DAYY Photonics, and contains proprietary information. DAYY Photonics reserves the right to make product design or specification changes without notice.

DAYY Photonics Corporation, 4030 8th St SE, Calgary, AB Canada, T2G 3A7
sales@dayyphotonics.com, +1 (587) 328-0739, www.dayyphotonics.com

A. PRODUCT DESCRIPTION

The Optical Spectral Engine (OSE2) ASM000008 is a broadband superluminescent diode (SLED) light source that operates within the near-infrared (NIR) region. It is a compact 32-pin butterfly package that provides an integrated optical interface and one of the highest power-density within the SLED technology industry.

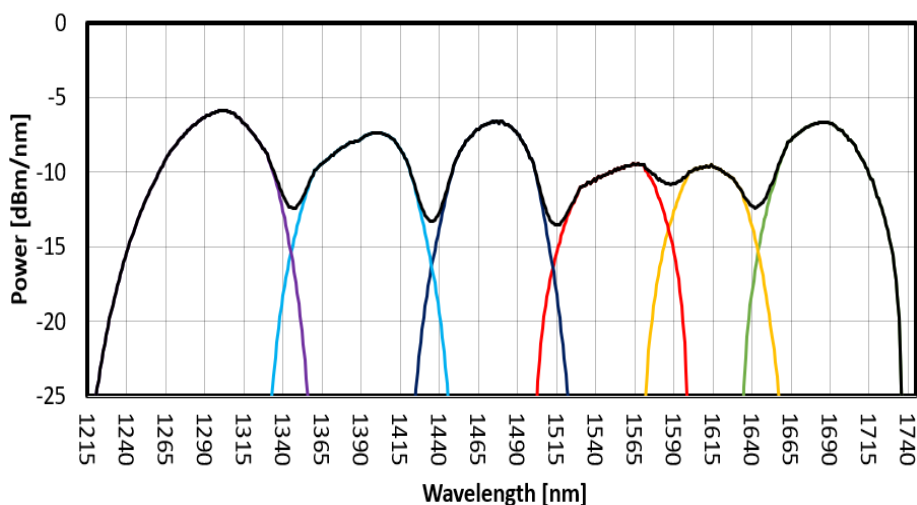
This SLED offers spectral coverage from 1265nm to 1725nm, with up to 40mW of optical power. The temperature of the device is regulated by an integrated thermoelectric cooler (TEC). This light source is compact and easy to use, making it an appropriate fit for many different types of manufactured assemblies requiring light power, including the applications below:

B. KEY FEATURES

- Six superluminescent diodes (SLEDs)
- All SLEDs can be run from 0 – 100% of maximum rating
- Output power: >40mW
- Bandwidth FWHM: 460nm
- Light output: FC/APC Connector (Optional FC/PC or SMA)
- DAYY Photonics' patented technology for spectral stitching provides optimum power and bandwidth
- Each SLED comes with a built-in independent monitor photodiode and one common thermoelectric cooler (TEC) for all SLEDs

C. APPLICATIONS

- Optical Component Testing
- Telecom Test Equipment
- Medical Optical Coherence Tomography
- Industrial Optical Coherence Tomography
- Metrology
- Biomedical Imaging Systems
- Optical Sensing
- White Light Interferometry & Chromatic Dispersion
- Research and Development



#DAY-OSE2-1300_1390_1480_1550_1615_1680-PM-HP-1265_1725-460-1495-40_DS_2026-01-01

This document is the property of DAYY Photonics, and contains proprietary information. DAYY Photonics reserves the right to make product design or specification changes without notice.

D. ABSOLUTE MAXIMUM RATINGS (see note 1)

Parameter	Symbol	Condition	Min.	Max.	Unit
Reverse Voltage (All SLEDs)	V_R	CW	-	2	V
Operating Current SLED 1 – 1680nm SLED 2 – 1615nm SLED 3 – 1550nm SLED 4 – 1480nm SLED 5 – 1390nm SLED 6 – 1300nm	I_{OP}	CW $T_{OSE2} = 25^{\circ}C$ $T_{TEC} = 21^{\circ}C$	-	450 350 550 400 450 550	mA
Forward Voltage SLED 1 – 1680nm SLED 2 – 1615nm SLED 3 – 1550nm SLED 4 – 1480nm SLED 5 – 1390nm SLED 6 – 1300nm	V_F	CW $T_{OSE2} = 25^{\circ}C$ $T_{TEC} = 21^{\circ}C$	-	3.0 2.5 3.0 2.5 2.5 2.8	V
OSE2 Package Temperature (see note 2)	T_{OSE2}		-40	80	$^{\circ}C$
SLED Operating Temperature (see note 3)	T_{SLED}	I_{OP}	0	70	$^{\circ}C$
TEC Current	I_{TEC}		-	10	A
TEC Voltage	V_{TEC}		-	9	V
TEC Temperature	T_{TEC}		0	50	$^{\circ}C$
Storage Temperature (see note 4)	T_{stg}	No condensation, Unbiased	-40	85	$^{\circ}C$
Storage Humidity (see note 4)	RH_{stg}		5	85	%RH
Electro Static Discharge (ESD)	V_{ESD}	Human Body Model	-	500	V
Lead soldering temperature	T_{Solder}		-	280	$^{\circ}C$
Lead soldering time	t_{Solder}		-	10	s

Notes:

1. Please note that exceeding the Absolute Maximum Ratings above may cause device failure. DAYY Photonics does not bear responsibility for laser power damage that is attributed to electrostatic discharge, excessive current levels, and current spikes (transients).

Any attempts to increase the laser drive current above the pre-set limits or recommended specification limits, can damage the device, and nullify the warranty period. It should be emphasized that the current limit set points cannot be exceeded.
2. For optimum performance of the Optical Spectral Engine (OSE2), the OSE2 must be operated within the specified temperature ranges. The Multi-SLED has an internal thermoelectric cooler (TEC) but it's always required to mount the OSE2 on an appropriate heatsink, capable of dissipating up to 15W.
3. T_{TEC} is monitored by internal thermistor with external readout.

4. Storage temperature and relative humidity should be chosen so the dew point of the humid air around the package is below the storage temperature of the package, to avoid condensation on the package.

E. OPTICAL AND ELECTRICAL SPECIFICATIONS (see note 5)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Center wavelength (see note 6)						
SLED 1 – 1680nm	CWL	CW T _{OSE2} = 25°C T _{TEC} = 21°C	1670	1680	1690	nm
SLED 2 – 1615nm			1605	1615	1625	
SLED 3 – 1550nm			1540	1550	1560	
SLED 4 – 1480nm			1470	1480	1490	
SLED 5 – 1390nm			1380	1390	1400	
SLED 6 – 1300nm			1290	1300	1310	
SLED 1+2+3+4+5+6			1485	1495	1505	
Operating Current						
SLED 1 – 1680nm	I _{OP}	CW T _{OSE2} = 25°C T _{TEC} = 21°C			400	mA
SLED 2 – 1615nm					300	
SLED 3 – 1550nm			-	-	500	
SLED 4 – 1480nm					350	
SLED 5 – 1390nm					400	
SLED 6 – 1300nm					500	
Forward Voltage						
SLED 1 – 1680nm	V _F	CW T _{OSE2} = 25°C T _{TEC} = 21°C			2.0	V
SLED 2 – 1615nm					2.0	
SLED 3 – 1550nm			-	-	2.5	
SLED 4 – 1480nm					2.0	
SLED 5 – 1390nm					2.0	
SLED 6 – 1300nm					2.0	
PM Fiber Coupled Power						
SLED 1 – 1680nm	P	CW T _{OSE2} = 25°C T _{TEC} = 21°C I _{OP}	3	7		mW
SLED 2 – 1615nm			3	5		
SLED 3 – 1550nm			3	6		
SLED 4 – 1480nm			3	7	-	
SLED 5 – 1390nm			3	7		
SLED 6 – 1300nm			3	8		
SLED 1+2+3+4+5+6						
Bandwidth FWHM (see note 7)						
SLED 1 – 1680nm	B _{FWHM}	CW T _{OSE2} = 25°C T _{TEC} = 21°C I _{OP}		55		nm
SLED 2 – 1615nm				45		
SLED 3 – 1550nm			-	60		
SLED 4 – 1480nm				50		
SLED 5 – 1390nm				65		
SLED 6 – 1300nm				60		
SLED 1+2+3+4+5+6						

Bandwidth @-10dB SLED 1 – 1680nm SLED 2 – 1615nm SLED 3 – 1550nm SLED 4 – 1480nm SLED 5 – 1390nm SLED 6 – 1300nm SLED 1+2+3+4+5+6	B@10dB	CW T _{OSE2} = 25°C T _{TEC} = 21°C I _{OP}	-	90 75 85 80 95 90 490	-	nm
Spectral Coverage	SC	CW T _{OSE2} = 25°C T _{TEC} = 21°C I _{OP}	-	1265- 1725	-	nm
Spectrum Ripple (see note 8) SLED 1 – 1680nm SLED 2 – 1615nm SLED 3 – 1550nm SLED 4 – 1480nm SLED 5 – 1390nm SLED 6 – 1300nm	R	CW T _{OSE2} = 25°C T _{TEC} = 21°C	< 0.15	< 0.30	0.5 0.35 0.5 0.45 0.35 0.45	dB
Polarization Extinction Ratio (see note 9)	PER	CW T _{OP} = 25°C T _{TEC} = 21°C I _{OP}	10	-	-	dB
RIN	RIN		-	< -130	-	dB/Hz
Thermistor Resistance TEC	R _{THTEC}	T _{OSE2} = 25°C T _{TEC} = 21°C	9.5	10.0	10.5	kΩ
Thermistor Resistance SLED 6	R _{THS6}	T _{OSE2} = 25°C T _{TEC} = 21°C	9.5	10.0	10.5	kΩ
Power Dissipation (see note 10)	P _{DISS}	I _{OP}	-	14	-	W
TEC Voltage	V _{TEC}		-	-	9	V
TEC Current	I _{TEC}		-	-	10	A

Notes:

5. *There may be differences in typical values of output power, power stability, wavelength and bandwidth, due to coupling efficiency. These values are references and there is no guarantee that each particular OSE2 module will have EXACTLY the typical values shown on the previous chart. The specification lists the operating temperature for the electrical/optical characteristics, which is the temperature of the OSE2 during the time that the specifications were measured. Variation in temperature beyond what is specified can have a significant effect on the optical characteristics, like changes in wavelength or drop in output power.*
6. *Center Wavelength is defined as the center point of the 3dB bandwidth of each individual SLED.*
7. *Multi-SLED FWHM is defined as the bandwidth from the lowest spectral dip, when all the SLEDs are on.*
8. *Resolution of 0.1nm. Figure of merit does not include dips between SLEDs.*
9. *Polarization Extinction Ratio is defined as the ratio of optical powers of perpendicular polarizations, expressed in decibels (dB).*
10. *Power dissipation when all SLEDs are on and |T_{OSE2} - T_{TEC}| is 40°C.*

F. PLOTS - Test performed at $T_{OP}=25^{\circ}C$ and $T_{TEC}=21^{\circ}C$

FIG. 1: OSE2 SPECTRUM

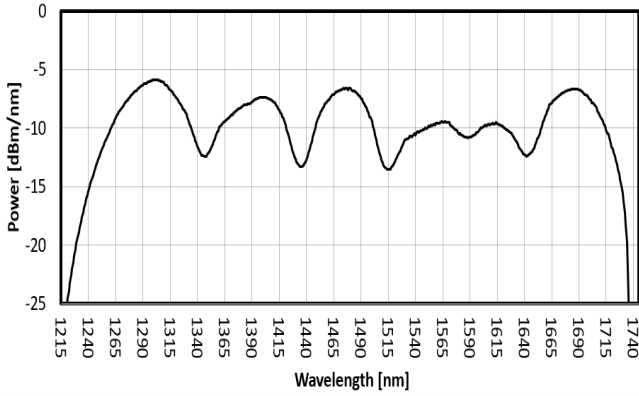


FIG. 2: SLED 1 SPECTRUM

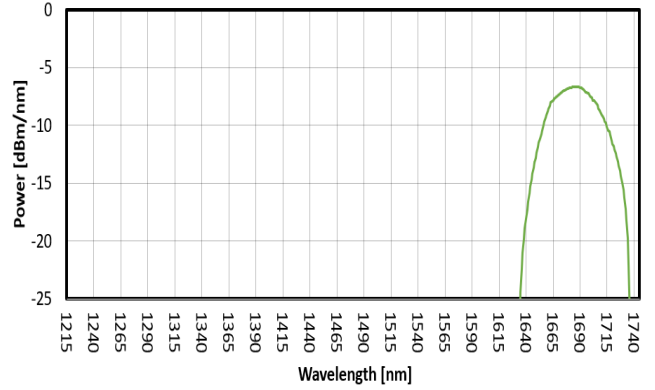


FIG. 3: SLED 2 SPECTRUM

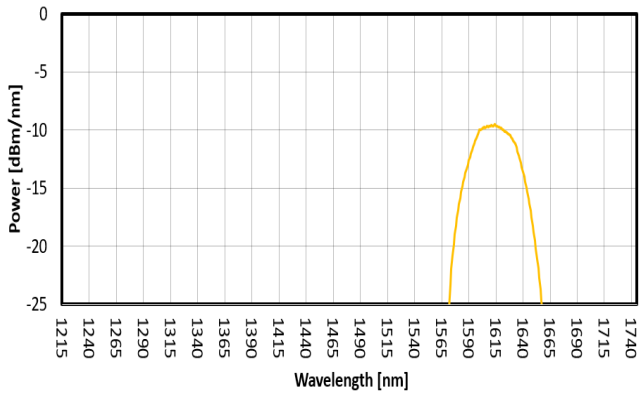


FIG. 4: SLED 3 SPECTRUM

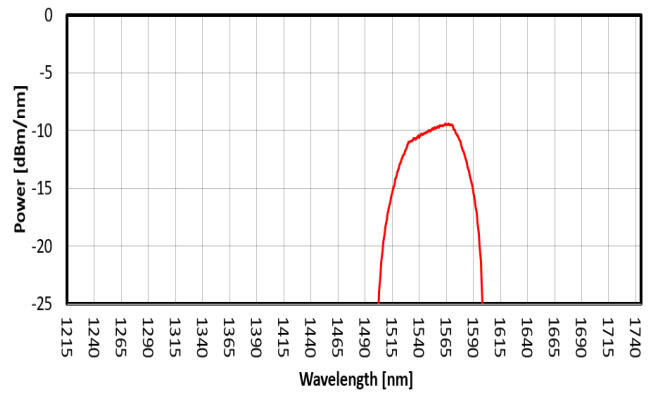


FIG. 5: SLED 4 SPECTRUM

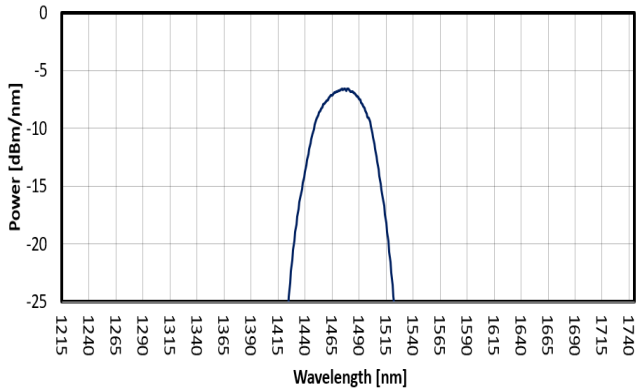


FIG. 6: SLED 5 SPECTRUM

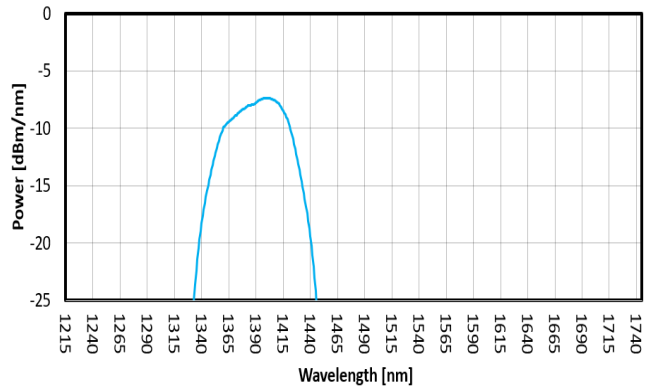


FIG. 7: SLED 6 SPECTRUM

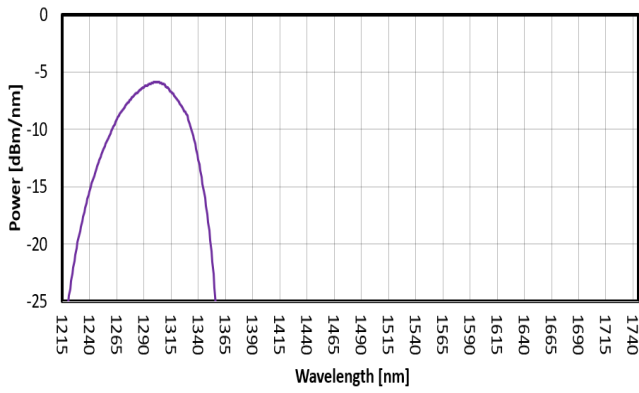


FIG. 8: SLED 1 OUTPUT POWER VS CURRENT

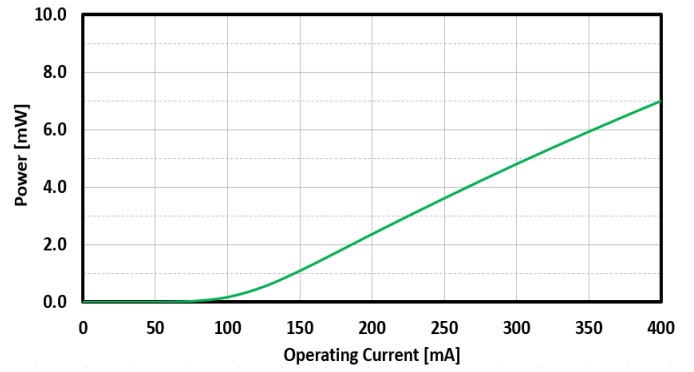


FIG. 9: SLED 2 OUTPUT POWER VS CURRENT

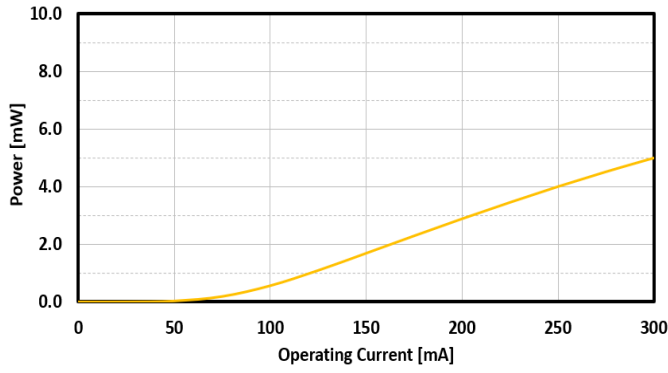


FIG. 10: SLED 3 OUTPUT POWER VS CURRENT

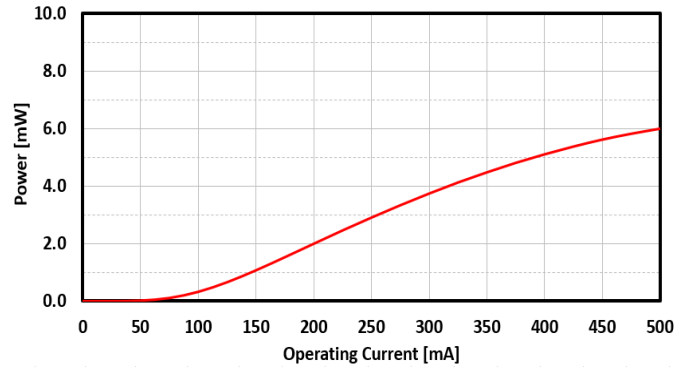


FIG. 11: SLED 4 OUTPUT POWER VS CURRENT

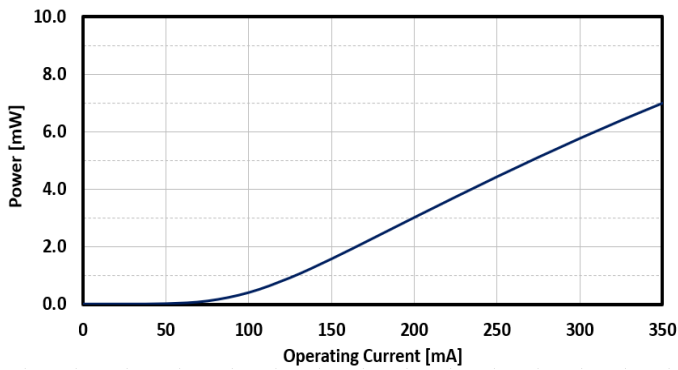


FIG. 12: SLED 5 OUTPUT POWER VS CURRENT

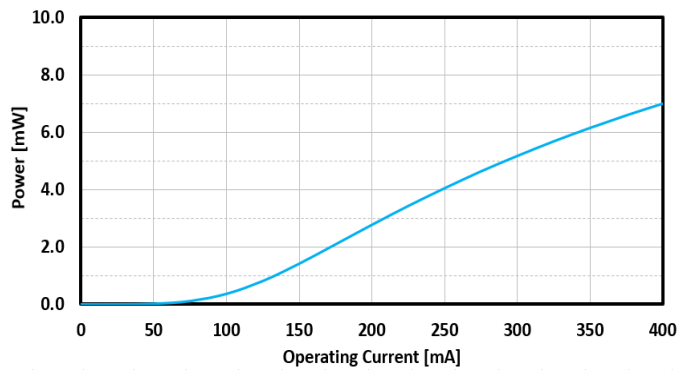


FIG. 13: SLED 6 OUTPUT POWER VS CURRENT

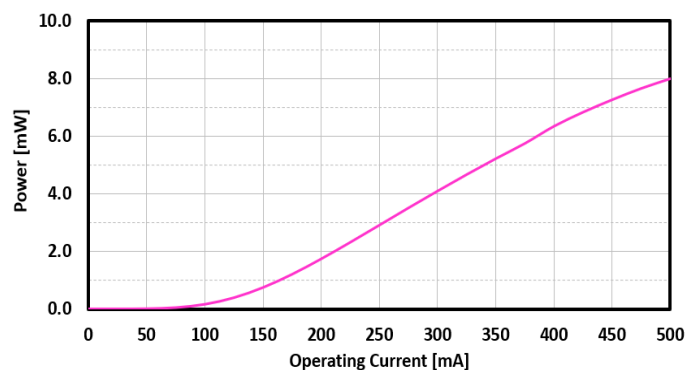


FIG. 14: SLED 1 FORWARD VOLTAGE VS CURRENT

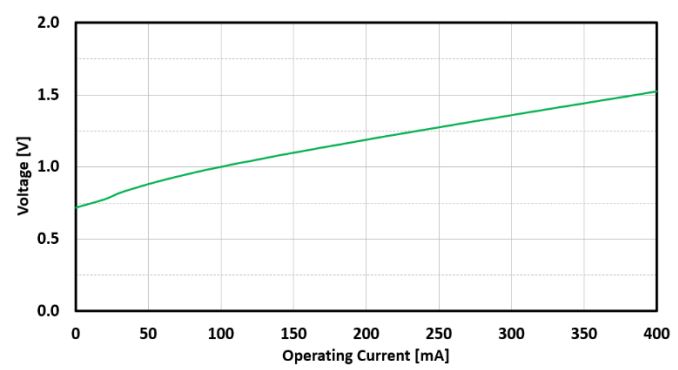


FIG. 15: SLED 2 FORWARD VOLTAGE VS CURRENT

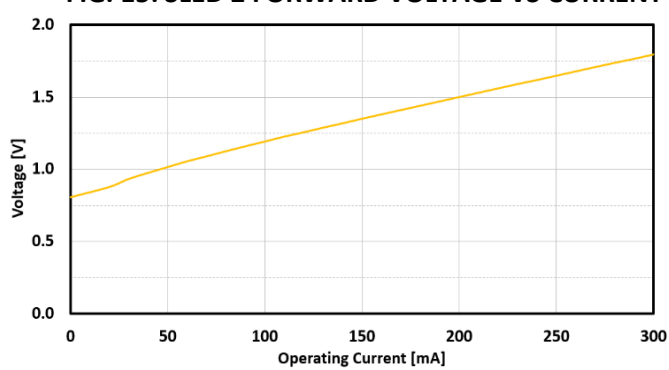


FIG. 16: SLED 3 FORWARD VOLTAGE VS CURRENT

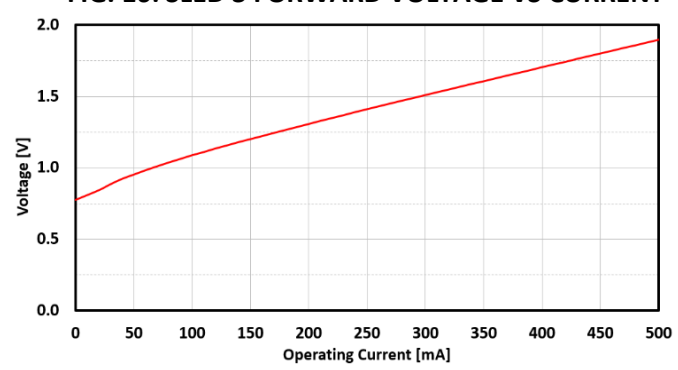


FIG. 17: SLED 4 FORWARD VOLTAGE VS CURRENT

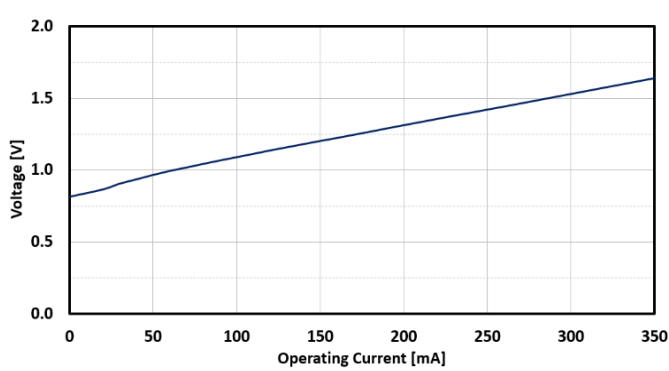


FIG. 18: SLED 5 FORWARD VOLTAGE VS CURRENT

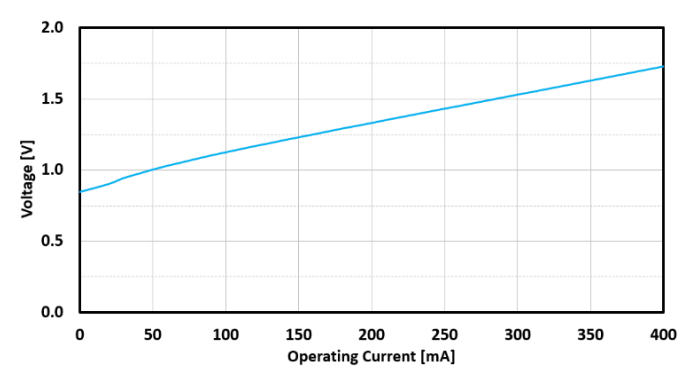


FIG. 19: SLED 6 FORWARD VOLTAGE VS CURRENT

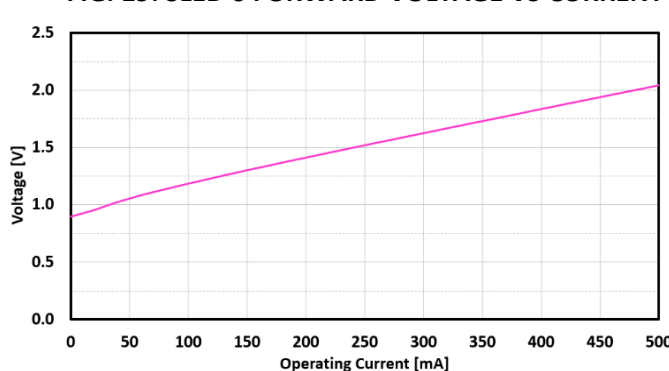
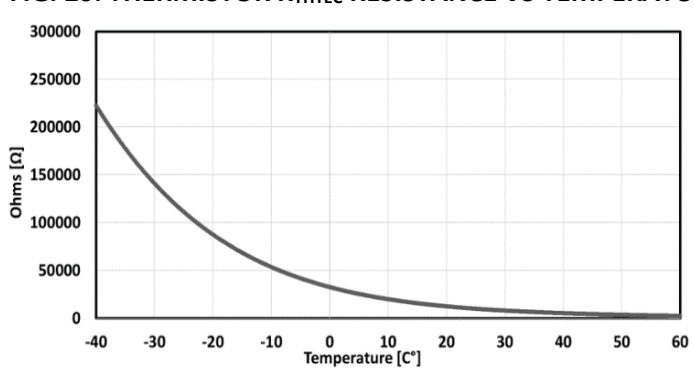


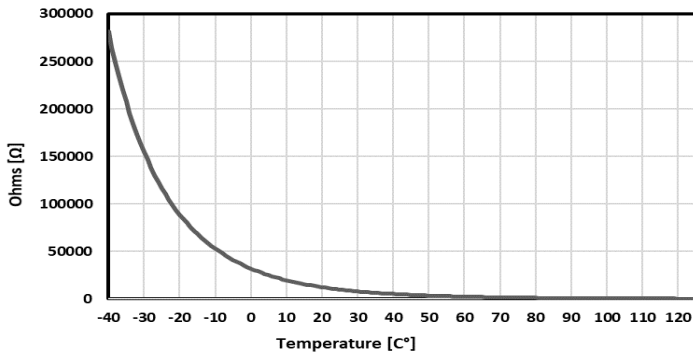
FIG. 20: THERMISTOR R_{THTEC} RESISTANCE VS TEMPERATURE



#DAY-0SE2-1300_1390_1480_1550_1615_1680-PM-HP-1265_1725-460-1495-40_DS_2026-01-01

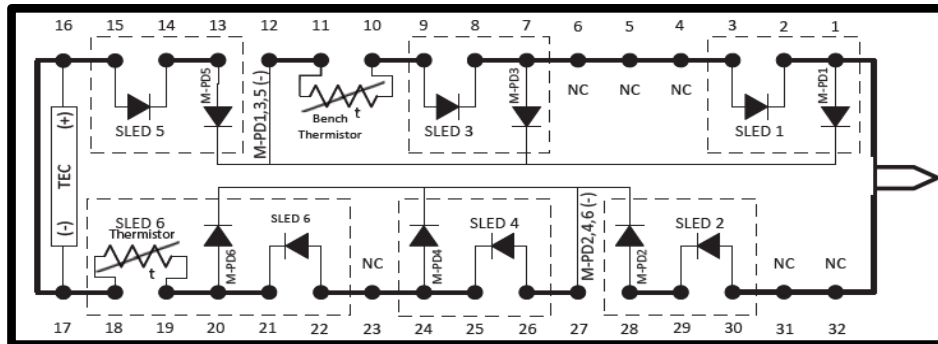
This document is the property of DAYY Photonics, and contains proprietary information. DAYY Photonics reserves the right to make product design or specification changes without notice.

FIG. 21: THERMISTOR R_{TH56} RESISTANCE VS TEMPERATURE

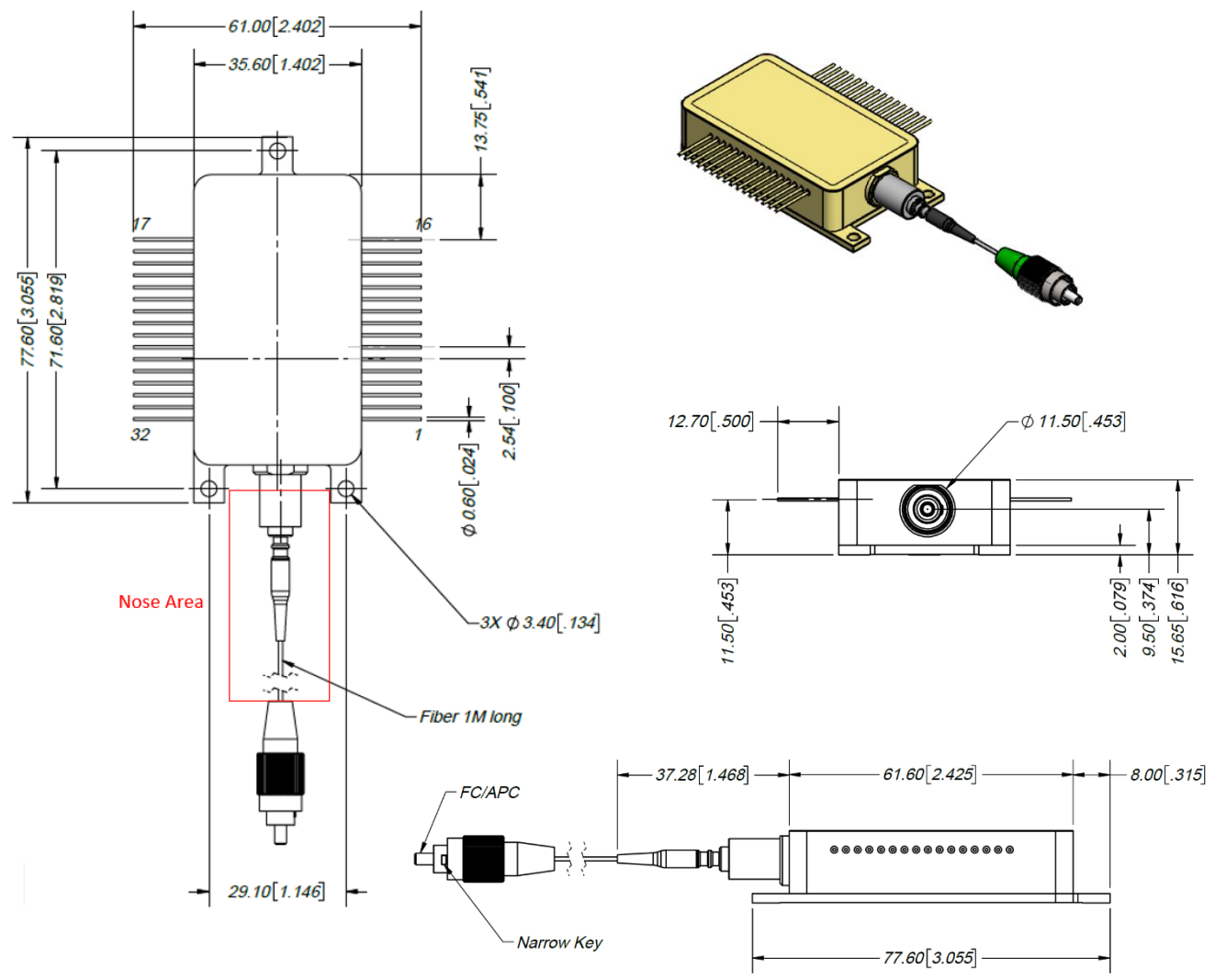


G. PIN OUT

External Pin Assignment – BeSt-SLED: 6 SLEDs							
1	M-PD1 (+)	9	SLED 3(+)	17	TEC (-)	25	SLED 4 (-)
2	SLED 1 (-)	10	Thermistor	18	SLED 6 Thermistor	26	SLED 4 (+)
3	SLED 1 (+)	11	Thermistor	19	SLED 6 Thermistor	27	M-PD2,4,6 (-)
4	NC	12	M-PD1,3,5 (-)	20	M-PD6 (+)	28	M-PD2 (+)
5	NC	13	M-PD5 (+)	21	SLED 6 (-)	29	SLED 2 (-)
6	NC	14	SLED 5 (-)	22	SLED 6 (+)	30	SLED 2 (+)
7	M-PD3 (+)	15	SLED 5 (+)	23	NC	31	NC
8	SLED 3 (-)	16	TEC (+)	24	M-PD4 (+)	32	NC



H. MECHANICAL DIAGRAM



I. MOUNTING RECOMMENDATIONS:

The OSE2 can be mounted on a flat cooling surface without having to risk forming the pins. Mounting surface should be flat, with no physical obstructions underneath to cause any discontinuity in the surface flatness. If a heatsink is used, the base of the butterfly package will rest on the surface of a heatsink in order to cool the internal TEC.

Use only the 3mm mounting holes in the case of the Multi-SLED, DAYY Photonics recommends the use of 18-8 Stainless Steel Socket Head Screw 5-40 Thread Size screws. Maximum torque to avoid damage to the device is 13 lb.in. /1.5 Nm. Minimum torque is 9 lb.in./1.1 Nm. Do not use self-tapping screws.

The OSE2 Light Source should be mounted so that mechanical vibrations cannot cause short circuits between leads. AZIMUTH 16 pin, 0.100" pitch Sockets are recommended. The 32 pins will rest on a pair of spring-loaded sockets and be squeezed between the contacts and a plastic clamp.

J. SAFETY

All statements regarding safety of operation and technical data will only apply when the unit is operated correctly.

The driver must not be operated in environments susceptible to explosion hazards. Do not obstruct the air ventilation slots. If any parts of the driver, or electronics are broken or exposed, contact DAYY Photonics technical support and do not attempt to operate the unit.

The OSE2 is a Class 1M laser product. It is safe for all conditions of use except when passed through magnifying optics such as microscopes and telescopes. It produces a beam that is divergent. If light is re-focused use protective eye wear.